### **TEBT0782 TRM**

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### Overview

The Trenz Electronic TEBT0782 is a carrier for TE0782, TE0783 and TE0784 module.

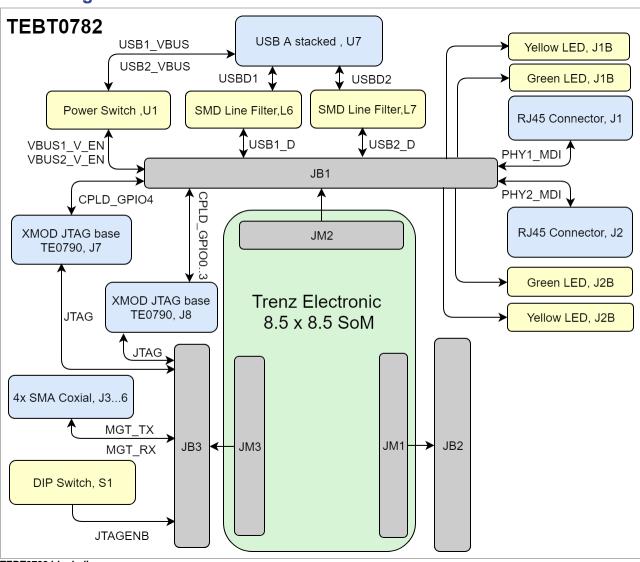
Refer to http://trenz.org/tebt0782-info for the current online version of this manual and other available documentation.

# **Key Features**

- 3 x Samtec ASP-122953-01 160-pin stackable, compatible with TE078x
- 2 mm MC LB2-A Soldered Connector for power supply (12V input)

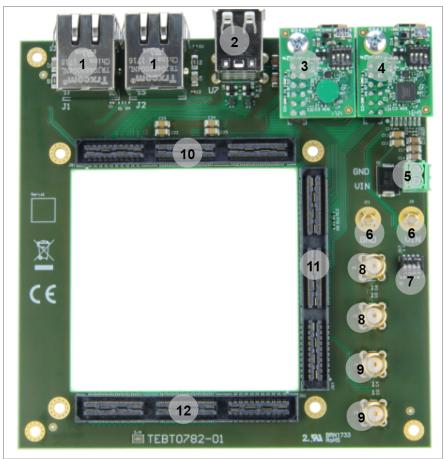
- 4 SMA connectors for MGT
- 2 x 12 pin headers for XMOD
- 1 x DIP switch for modules CPLD Access
- 2 x RJ45 Connector
- USB A Stacked Connector
- Equipped with two TE0790 XMOD FTDI JTAG adapters
- Voltage regulators
- Dimension: 115 x 115 mm

### **Block Diagram**



TEBT0782 block diagram

# **Main Components**



#### **TEBT0782** main components

- 1. RJ45 Transceivers, J1-J2
- 2. USB A Stacked, U7
- 3. XMOD JTAG/UART Adapter, J7
- 4. JTAG CPLD Adapter -J8
- 5. 2 Line Common Mode Choke, J106. Non-isolated power jack (VIN), J9-J11
- 7. DIP Switch, S1
- 8. SMA Coxial Connectors (MGT\_TX), J3-J4
   9. SMA Coxial Connectors (MGT\_RX), J5-J6
   10. Board to Board Connector, JB1
- 11. Board to Board Connector, JB3
- 12. Board to Board Connector, JB2

# **Initial Delivery State**

| Storage device name | Content | Notes |
|---------------------|---------|-------|
| -                   | -       | -     |

Initial delivery state of programmable devices on the module

# **Configuration Signals**

The general Reset is provided through button S1 on TE0790 XMOD J7.

| Signal | B2B      | Note        |
|--------|----------|-------------|
| RESIN  | JBC3-130 | Board Reset |

Reset process.

# Signals, Interfaces and Pins

# Board to Board (B2B) I/Os

FPGA bank number and number of I/O signals connected to the B2B connector:

| B2B Connector | Interface                         | Number of I/O                         | Notes                      |
|---------------|-----------------------------------|---------------------------------------|----------------------------|
| JB1           | RJ45, J1B-J1C                     | 1 Differential pair, 2 Single Ended   | Yellow, Green LEDs         |
|               | RJ45, J1A                         | 4 Differential pair, 8 Single Ended   | PHY1 MDIO                  |
|               | RJ45, J2B-J2C                     | 1 Differential pair, 2 Single Ended   | Yellow, Green LEDs         |
|               | RJ45, J2A                         | 4 Differential pair, 8 Single Ended   | PHY2 MDIO                  |
|               | TE0790 Base, J8                   | 4 Single Ended                        |                            |
|               | TE0790 Base, J7                   | 1 Single Ended                        |                            |
|               | USB A Stacked, U7                 | 2 Single Ended                        | USB                        |
|               | Power Switch, U1                  | 2 Single Ended                        |                            |
|               | SMD Line Filter, L6               | 1 Differential pair, 2 Single Ended   | USB1_D                     |
|               | SMD Line Filter, L7               | 1 Differential pair, 2 Single Ended   | USB2_D                     |
|               | ESD protection diode, U5          | 1 Single Ended                        | USB1_VBUS                  |
|               | ESD protection diode, U8          | 1 Single Ended                        | USB2_VBUS                  |
| JB2           | Module TE078x FPGA, Bank 111-112  | 16 Differential pair, 32 Single Ended | MGT_RX815, MGT_TX815       |
|               | Module TE078x FPGA, Bank 34       | 1 Differential pair, 2 Single Ended   | J1_B34_VRP, J1_B34_VRN     |
|               | Module TE078x FPGA, Bank 34       | 1 Differential pair, 2 Single Ended   | J1_B33_VRP, J1_B33_VRN     |
| JB3           | TE0790 Base, J8                   | 4 Single Ended                        | M_TCK, M_TMS, M_TDO, M_TDI |
|               | TE0790 Base, J7                   | 4 Single Ended                        | TCK, TMS, TDO, TDI         |
|               |                                   | 2 Single Ended                        | UART RX/TX                 |
|               |                                   | 1 Single Ended                        | RESIN                      |
|               | DIP Switch, S1-A                  | 1 Single Ended                        | JTAGENB                    |
|               | SMA Coaxial, J36                  | 2 Differential pair, 4 Single Ended   | MGT_RX0, MGT_TX0           |
|               | Module TE07824 FPGA, Bank 109-110 | 16 Differential pair, 32 Single Ended | MGT_RX17, MGT_TX07         |

General I/O to B2B connectors information

### **XMOD Pin Header**

#### JTAG/UART to Module SoC/FPGA

JTAG access to the TE078x SoM is available through B2B connector JB3. JTAG access is provided by TE0790 XMOD Adapter on Pin Header J7.

| JTAG Interface Pins | Signal Name | B2B Connector | Notes         |
|---------------------|-------------|---------------|---------------|
| A                   | XMOD_A      | JB3C-129      | UART          |
| В                   | XMOD_B      | JB3C-135      | UART          |
| С                   | тск         | JB3C-141      | JTAG          |
| D                   | TDO         | JB3C-148      | JTAG          |
| E                   | CPLD_GPIO4  | JB1A-18       |               |
| F                   | TDI         | JB3C-147      | JTAG          |
| G                   | RESIN       | JB3C-130      | General Reset |
| Н                   | TMS         | JB3C-142      | JTAG          |
| 3.3V                | 3.3V_M      | JB1- JB3      |               |
| VIO                 | 3.3V_M      | JB1- JB3      | 3.3V          |

JTAG pins connection

#### JTAG/ GPIO to Module CPLD

JTAG access to the System Controller CPLD is provided through B2B connector J3. JTAG access to CPLD is provided by TE0790 XMOD Adapter on Pin Header J8.

Pin 'JTAGENB' must be set high, using DIP Switch S1-A in order to program the System Controller CPLD via JTAG interaface.

| JTAG Interface Pins | Signal Name | B2B Connector | Notes |
|---------------------|-------------|---------------|-------|
| A                   | CPLD_GPIO0  | JB1A-10       |       |
| В                   | CPLD_GPIO1  | JB1A-12       |       |
| С                   | M_TCK       | JB3B-81       |       |
| D                   | M_TDO       | JB3B-88       |       |
| Е                   | CPLD_GPIO2  | JB1A-14       |       |
| F                   | M_TDI       | JB3B-87       |       |
| G                   | CPLD_GPIO3  | JB1A-16       |       |
| Н                   | M_TMS       | JB3B-82       |       |
| 3.3V                | 3.3V_CPLD   | JB1- JB3      |       |
| VIO                 | 3.3V_CPLD   | JB1- JB3      | 3.3V  |

#### **CPLD JTAG pins connection**

DIP Switch S2 on TE0790 must be set and fixed like the following table.

| DIP Switch | Setting | Notes   |
|------------|---------|---|
| S2-1       | ON      | JTAGENB (Enable/Disable module JTAG CPLD IOs) |
| S2-2       | OFF     | NC  |
| S2-3       | OFF     | NC  |
| S2-4       | OFF     | NC  |

#### XMOD DIP Switch Setting

### **RJ45 Connectors**

| Signal Name | RJ45-J1 Pin | RJ45-J2 Pin | Notes            |
|-------------|-------------|-------------|------------------|
|             | B2          | В           |                  |
| PHY_MDI0_P  | JB1A-23     | JB1A-39     |                  |
| PHY_MDI0_N  | JB1A-21     | JB1A-37     |                  |
| PHY_MDI1_P  | JB1A-19     | JB1A-35     |                  |
| PHY_MDI1_N  | JB1A-17     | JB1A-33     |                  |
| PHY_MDI2_P  | JB1A-15     | JB1A-31     |                  |
| PHY_MDI2_N  | JB1A-13     | JB1A-29     |                  |
| PHY_MDI3_P  | JB1A-11     | JB1A-27     |                  |
| PHY_MDI3_N  | JB1A-9      | JB1A-25     |                  |
| J2_TX9_P    | JB1A-95     | -           | LED Green/Yellow |
| J2_TX9_N    | JB1A-97     | -           | LED Green/Yellow |
| J2_RX9_N    | -           | JB1A-96     | LED Green/Yellow |
| J2_RX9_P    | -           | JB1A-98     | LED Green/Yellow |

**RJ45s Connections to B2B Connectors** 

### **USB A Stacked Socket**

The USB A Stacked (U7) is a dual port USB Socket which provides two USB ports.

| Signal Name | Port A  |                     | Port B  |                     | Notes |
|-------------|---------|---------------------|---------|---------------------|-------|
|             | B2B     | Connected to        | B2B     | Connected to        |       |
| USB_D_P     | JB1A-28 | SMD Line Filter, L7 | JB1A-40 | SMD Line Filter, L6 |       |
| USB_D_N     | JB1A-26 | SMD Line Filter, L7 | JB1A-38 | SMD Line Filter, L6 |       |
| USB_VBUS    | JB1A-24 | SMD Line Filter, L7 | JB1A-36 | SMD Line Filter, L6 |       |
| VBUS_V_EN   | JB1A-30 | Power Switch, U1    | JB1A-32 | Power Switch, U1    |       |

**Dual Port USB Connections** 

### **SMA Coaxial**

The TEBT0782 carrier is equipped with 4x SMA Coaxial straight connectors.

| Designator | Schematic | B2B     | Notes    |
|------------|-----------|---------|----------|
| J3         | MGT_TX0_N | JB3A-29 | Transfer |
| J4         | MGT_TX0_P | JB3A-31 | Transfer |
| J5         | MGT_RX0_N | JB3A-30 | Receive  |
| J6         | MGT_RX0_P | JB3A-32 | Receive  |

**SMAs Connections** 

### **Test Points**

| Test Point | Signals   | B2B Connector | Notes |
|------------|-----------|---------------|-------|
| TP 1       | VBAT_I    | JB3-124       |       |
| TP 2       | OTG2_ID   | JB1-22        |       |
| TP 3       | OTG1_ID   | JB1-34        |       |
| TP 4       | USB1_VBUS | JB1-36        |       |
| TP 5       | USB2_VBUS | JB1-24        |       |
| TP 6       | M_TCK     | JB3-81        |       |
| TP 7       | M_TDO     | JB3-88        |       |
| TP 8       | M_TDI     | JB3-87        |       |
| TP 9       | M_TMS     | JB3-82        |       |
| TP 10      | тск       | JB3-141       |       |
| TP 11      | TDO       | JB3-148       |       |
| TP 12      | TDI       | JB3-147       |       |
| TP 13      | TMS       | JB3-142       |       |
| TP 14      | VIN       | JB1-165168    |       |
| TP 15      | 5V        | -             |       |
| TP 16      | 3.3V_CPLD | JB1-147148    |       |
| TP 17-18   | GND       | -             |       |

**Test Points Information** 

# **On-board Peripherals**

| Chip/Interface | Designator | Notes |
|----------------|------------|-------|
| DIP Switch     | S1         |       |

On board peripherals

### **DIP Switch**

| Switch | Connected to | B2B      | Notes         |
|--------|--------------|----------|---------------|
| S1-A   | JTABENB      | JB3C-136 |               |
| S1-BD  | -            | -        | Not connected |

**DIP Switch Connections** 

# Power and Power-On Sequence

# **Power Supply**

Power supply with minimum current capability of 3A for system startup is recommended.

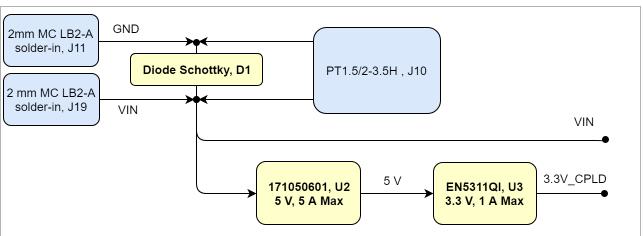
### **Power Consumption**

| Power Input Pin | Typical Current |
|-----------------|-----------------|
| VIN             | TBD*            |

**Power Consumption** 

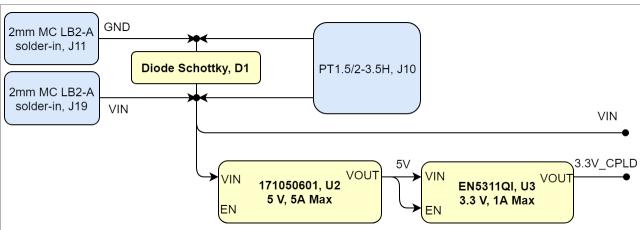
### **Power Distribution Dependencies**

12V power supply (VIN) on J9/J11 (2 mm MC LB2-A solder-in) or on J10 (TE1.5/2-3.5H).



Power Distribution

# **Power-On Sequence**



**Power Sequency** 

<sup>\*</sup> TBD - To Be Determined

#### **Power Rails**

| Power<br>Rail Name | B2B JB1 Pin  | B2B JB2 Pin                             | B2B JB3<br>Pin       | Direction    | Notes  |
|--------------------|--|---|----------------------|--------------|--|
| VIN                | 165, 166, 167, 168   | -                                       | -                    | Input/Output | Directly to module   |
| 3.3V_M             | 99, 100, 111,112, 123, 124, 135, 136, 159, 160, 169, 170, 171, 172 | -                                       | 99, 100,<br>159, 160 | Input/Output | 160, 169, 170, 171, 172 are output other ones input for IO Banks |
| 3.3V_CPLD          | 147,148  | -                                       | -                    | Output       | Directly to module   |
| 1.8V_M             | -  | 99,100, 159, 160, 169,<br>170, 171, 172 | 124                  | Input/Output | 169, 170, 171, 172 are output other ones input for IO Banks      |
| VBAT_IN            |  |   |                      |              |  |

Module power rails.

### **Board to Board Connectors**

8.5 x 8.5 SoMs have three Samtec Q Strip Socket on the bottom side.

- Module use 3 x ASP-122952-01 (QTH-090-01-L-D-A) , (180 pins, "60" per bank)
   Carrier use 3 x ASP-122953-01 (QSH-090-01-F-D-A), (180 pins, "60" per bank)

| Connector Specifications    | Value                            |
|-----------------------------|----------------------------------|
| Insulator material          | Black Liquid Crystal Polymer     |
| Stacking height             | 5 mm                             |
| Contact material            | Phosphor-bronze                  |
| Plating                     | Au or Sn over 50 μ" (1.27 μm) Ni |
| Current rating              | 2 A per pin (2 pins powered)     |
| Operating temperature range | -55 °C to +125 °C                |
| RoHS compliant              | Yes                              |

#### Connector specifications.

#### Connector Mating height

When using the same type on baseboard, the mating height is 5mm. Other mating heights are possible by using connectors with a different height

| Order number | Connector on baseboard | compatible to Mating height |      |
|--------------|------------------------|-----------------------------|------|
|              | ASP-122953-01          | QTH-090-01-L-D-A            | 5 mm |
|              | ASP-122952-01          | QSH-090-01-F-D-A            | 5 mm |

#### Connectors.

The module can be manufactured using other connectors upon request.

#### **Connector Speed Ratings**

The Q Strip connector speed rating depends on the stacking height; please see the following table:

| Stacking height     | Speed rating        |
|---------------------|---------------------|
| 5 mm, Single-Ended  | 9.5 GHz             |
| 8 mm, Single-Ended  | 8.5 GHz             |
| 11 mm, Single-Ended | 6 GHz               |
| 16 mm, Single-Ended | 5.5 GHz             |
| 20 mm, Single-Ended | 3.5 GHz             |
| 30 mm, Single-Ended | 3 GHz               |
| 5 mm, Differential  | 10.5 GHz / 25Gbit/s |
| 8 mm, Differential  | 8 GHz               |
| 11 mm, Differential | 5 GHz               |
| 16 mm, Differential | 6 GHz               |
| 20 mm, Differential | 8.5 GHz             |
| 30 mm, Differential | 1.5 GHz             |

#### Speed rating.

#### **Current Rating**

Current rating of Samtec Q Strip Socket B2B connectors is 2A per pin (2 adjacent pins powered).

#### Connector Mechanical Ratings

- Shock: 50 G, 11 ms half Sine
  Vibration: 7.3G random, 2 hours per axis, 3 axes total

#### **Manufacturer Documentation**

| File                                      | Modified                        |
|---|---------------------------------|
| PDF File qsh.pdf                          | 23 07, 2019 by Pedram Babakhani |
| PDF File qsh-xxx-01-x-d-xx-footprint.pdf  | 24 07, 2019 by Pedram Babakhani |
| PDF File qsh-xxx-01-x-d-xxx-mkt.pdf       | 24 07, 2019 by Pedram Babakhani |
| PDF File qth.pdf                          | 23 07, 2019 by Pedram Babakhani |
| PDF File qth-xxx-xx-x-d-xxx-footprint.pdf | 24 07, 2019 by Pedram Babakhani |
| PDF File qth-xxx-xx-x-d-xxx-mkt.pdf       | 24 07, 2019 by Pedram Babakhani |

#### Download All

# **Technical Specifications**

# **Absolute Maximum Ratings**

| Symbols | Description          | Min | Max | Unit | Note                                    |
|---------|----------------------|-----|-----|------|---|
| VIN     | Input supply voltage |     |     | V    | Attention: Depends on connected module! |
|         |                      |     |     |      | 171050601 of the TEBT0782 (-0,3V - 40V) |
| T_STG   | Storage Temperature  | -40 | +85 | °C   | DIP Switch S1                           |

PS absolute maximum ratings

# **Recommended Operating Conditions**

Operating temperature range depends also on customer design and cooling solution. Please contact us for options.

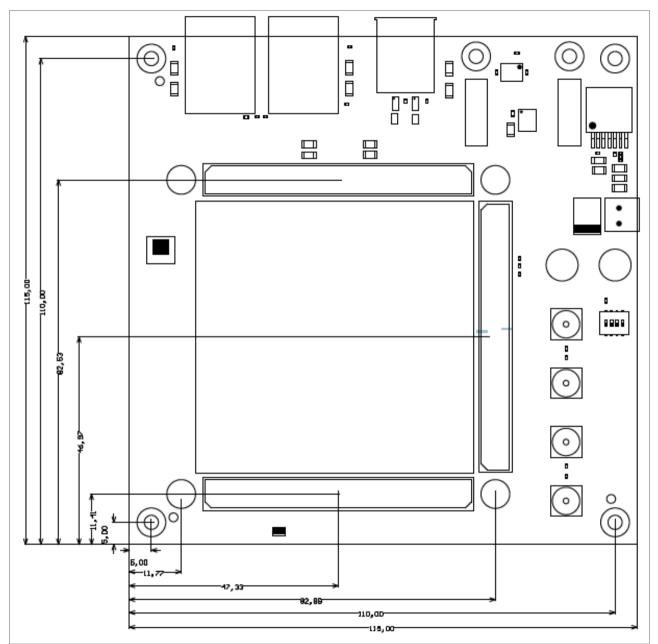
| Parameter | Min  | Max  | Units | Reference Document  |
|-----------|------|------|-------|---|
| VIN       | 11.4 | 12.6 | V     | Attention: Depends on connected module! See TE078x TRMs, recommended normally 12V |
|           |      |      |       | Without module: 171050601 of the TEBT0782 (6V - 36V)                              |
| T_OPT     | -40  | +85  | °C    |   |

Recommended operating conditions.

# **Physical Dimensions**

- Module size: 116 mm x 116 mm. Please download the assembly diagram for exact numbers.
   Mating height with standard connectors: 5 mm.

PCB thickness: 1.6 mm.



Physical Dimension

# **Currently Offered Variants**

| Trenz shop TEBT0728 overview page |             |
|-----------------------------------|-------------|
| English page                      | German page |

**Trenz Electronic Shop Overview** 

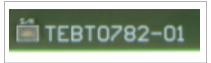
# **Revision History**

# **Hardware Revision History**

| Date       | Revision | Changes         | Documentation Link |
|------------|----------|-----------------|--------------------|
| 2016-11-05 | 01       | Initial Release | REV01              |

#### **Hardware Revision History**

Hardware revision number can be found on the PCB board together with the module model number separated by the dash.



Board hardware revision number.

# **Document Change History**

|  | Date | Revision | Contributor | Description |  |
|--|------|----------|-------------|-------------|--|
|--|------|----------|-------------|-------------|--|

# Error rendering macro 'pageinfo'

Ambiguous method overloading for method jdk. proxy241.\$Proxy3496#hasCon tentLevelPermission. Cannot resolve which method to invoke for [null, class java. lang.String, class com. atlassian.confluence.pages. Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user. ConfluenceUser, class java. lang.String, class com. atlassian.confluence.core. ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core. ContentEntityObject]

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 update power section

| 2019-10-8  | v.45 | John Hartfiel    | <ul><li>update power section</li><li>XMOD section</li></ul> |
|------------|------|------------------|---|
| 2019-10-16 | v.44 | Pedram Babakhani | • Initial Release   |

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Document change history.

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## **Data Privacy**

Please also note our data protection declaration at https://www.trenz-electronic.de/en/Data-protection-Privacy

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Ambiguous method overloading for method jdk.proxy241.\$Proxy3496#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com. atlassian.confluence.user.ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]